



REV	MODIFICATION	DATE	DRAW
A0	Release To ECN20150805	2015.08.05	Michelle
A1	Release To ECN20151204	2015.12.22	Michelle

RoHS Compliant

Specification

- 1.Current Rating:2A AC/DC
- 2.Voltage Rating:100V AC/DC
- 3.Contact Resistance:20mΩ Max.
- 4.Insulation Resistance:1000MΩ Min. At DC500V
- 5.Dielectric Withstanding Voltage:AC800V/Minute
- 6.Operating Temperature:-25°C~+85°C

Material:

- 1.Housing:High Temperature Thermoplastic UL94V-0
- 2.Contact Pin:Copper Alloy SQ. Pin 0.50mm

Finish:

- 1.Housing:Natural

△AI 2.Contact Pin:See P/N Option

△AI Part No.: AD05600 XX 4 X 5 2

No. Of Pin
02~16

Packing
5:Bag

Housing Material

4:Nylon66+GF UL94V-0 Natural

Plated

4:Matte Tin Plated
Over Nickel With Kink

△AI C:Gold Plated Over
Nickel With Kink

Remark: No. Of Pin 11~16Pin MOQ:10,000/LOT



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GOLDENSUNDA TECHNOLOGY CO.,LTD

TOLERANCE UNLESS OTHERWISE SPECIFIED		PROV.	TITLE: Wire To Board Wafer 2.00mm 180° DIP Single Row With Kink			
.X± 0.35	X.± 2'	APR. C.F.Liao 20151222	PART NO. AD05600XX4X52		DWG NO. AD05600XX4X52	
.XX± 0.25	.X± 1'	CHK. Abel 20151222	UNITS: mm	CUSTOMER DRAWING		
.XXX± 0.15	.XX± 0.5'	DRAW Michelle 20151222	SIZE: A4	SCALE 5:1	SHEET 1 / 1	
			REV A1	V		